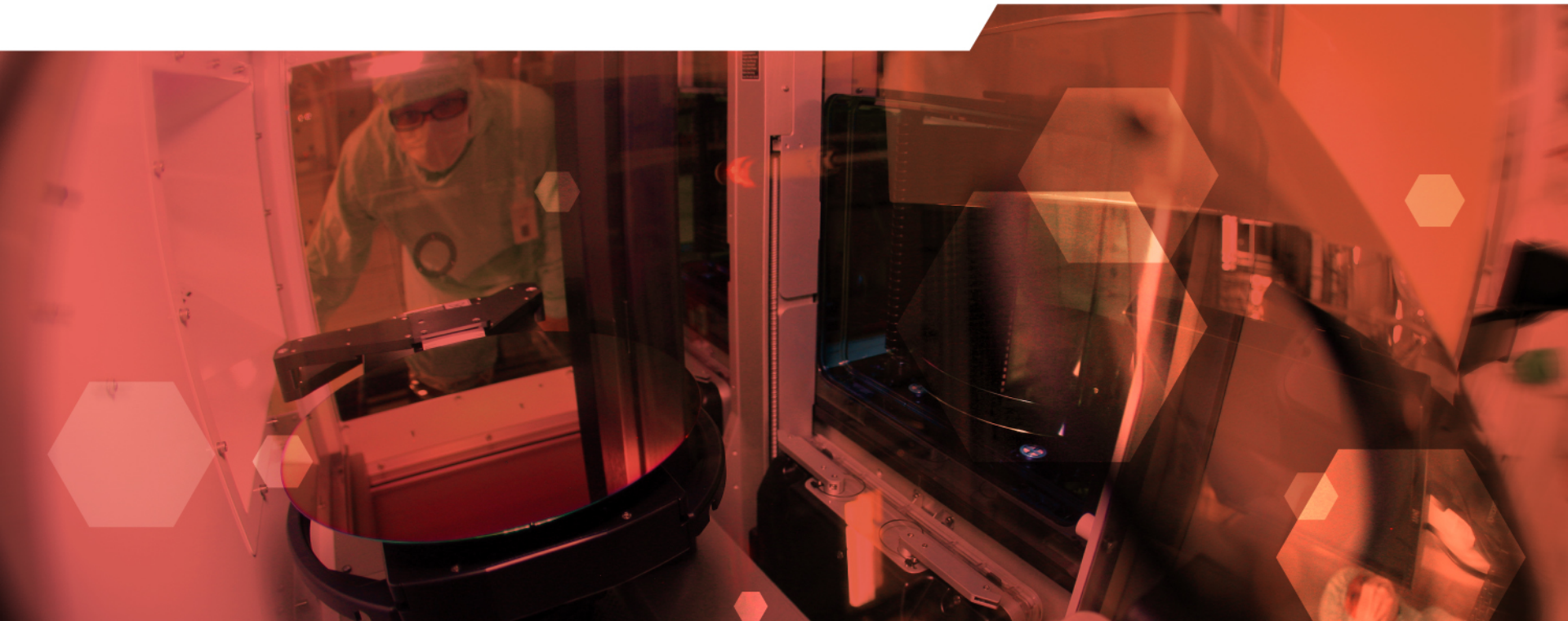


Korea HB-LED Chapter Formation Group Liaison Repot

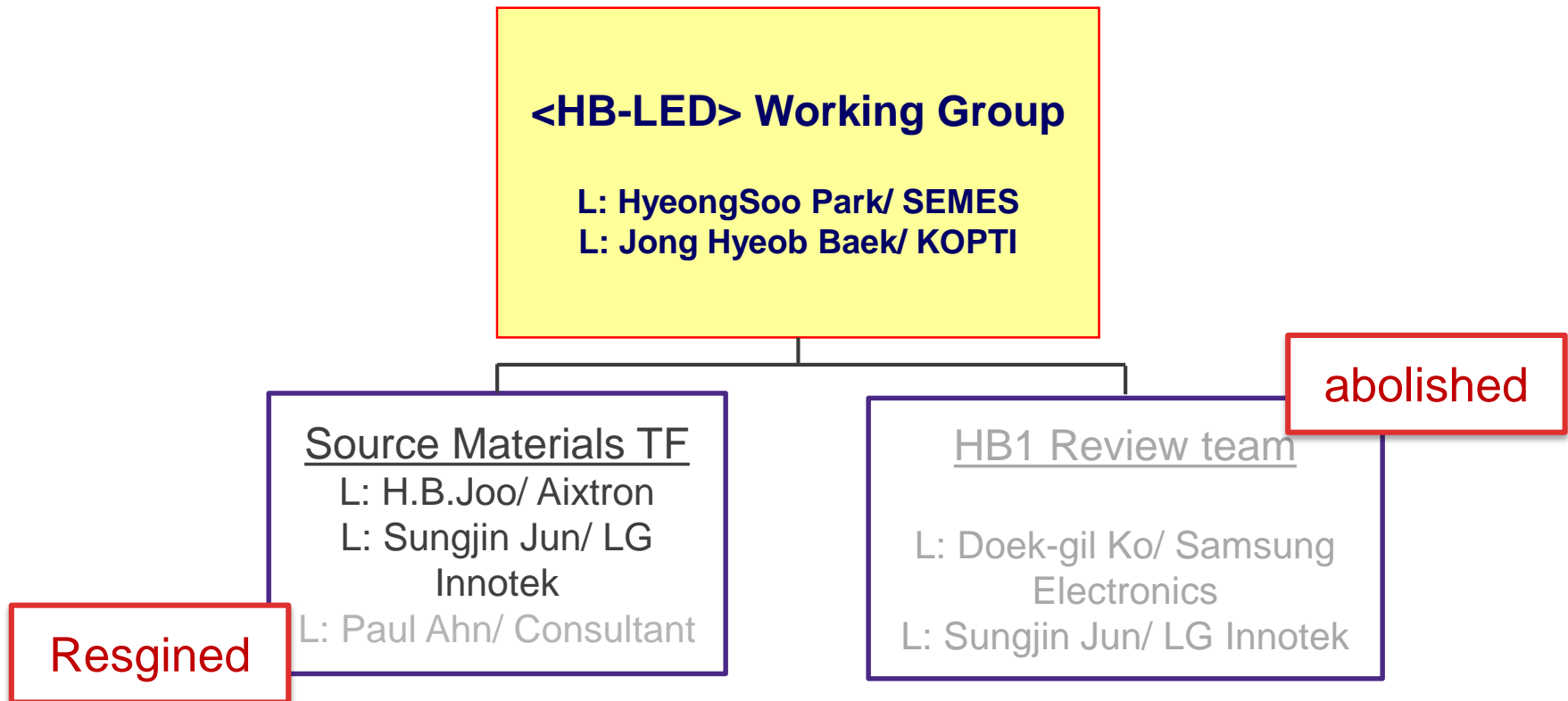
July 2017



Outline

- Organization Chart
- Meeting Information
- Task Force Updates

Organization Chart



Meeting Information

- Last meeting
 - February 7, 2017 in conjunction with SEMICON Korea
- Next meeting
 - TBD

Major Updates

- HB-LED Wafer Team
 - As HB1 Revision activity is completed, the team decided to be disbanded.
- HB-LED Source Material Task Force
 - TF requests NA HB-LED TC Chapter for Paul Ahn's resignation of TF co-leader.
 - The TF amended 5 drafts and ask ballot authorization for cycle 7, 2017 to NA HB-LED TC Chapter.
 - 5984 (Guide for Biscyclopentadienylmagnesium (Cp₂Mg) for HB-LED Manufacutring)
 - 5985 (Guide for Triethylgallium (TEGa) for HB-LED Manufacutring)
 - 5986 (Guide for Trimethylaluminum (TMAI) for HB-LED Manufacutring)
 - 5987 (Guide for Trimethylgallium (TMGa) for HB-LED Manufacutring)
 - 5988 (Guide for Triethylgallium (TEGa) for HB-LED Manufacutring)

Thank you

*For more information or participate in
any Korea activities, please contact
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